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**Huang et al.**

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(54) **LOW NOISE CASCODE AMPLIFIER**

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(73) Assignee: **National Taiwan University**, Taipei (TW)

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\* cited by examiner

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(30) **Foreign Application Priority Data**

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(57) **ABSTRACT**

(51) **Int. Cl.**  
**H03F 1/22** (2006.01)

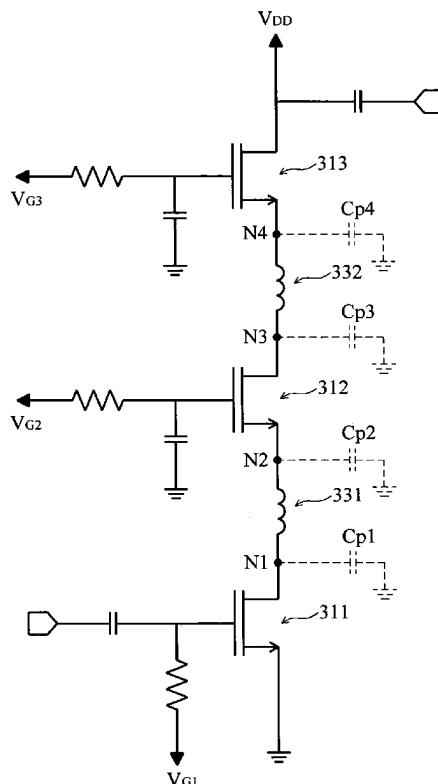
The present invention relates to a low noise cascode amplifier comprising a first transistor, a second transistor, a third transistor, a first inductor, and a second inductor. Furthermore, the first transistor can connect with the second transistor via the first inductor, and the second transistor can connect with the third transistor via the second inductor; thereby, a cascode device can be formed. The inductor and the parasitic capacitances can resonate at high frequency, so that the noise figure of the cascode amplifier can be reduced.

(52) **U.S. Cl.** ..... 330/311

(58) **Field of Classification Search** ..... 330/277, 330/302, 311

See application file for complete search history.

**11 Claims, 9 Drawing Sheets**



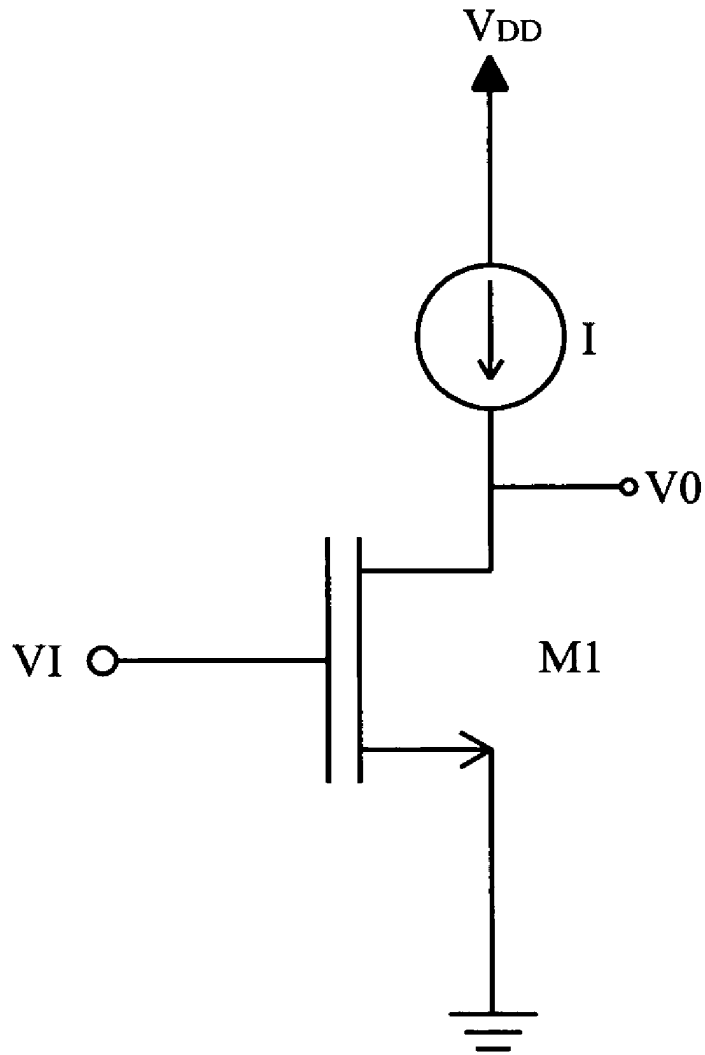


FIG.1  
(PRIOR ART)

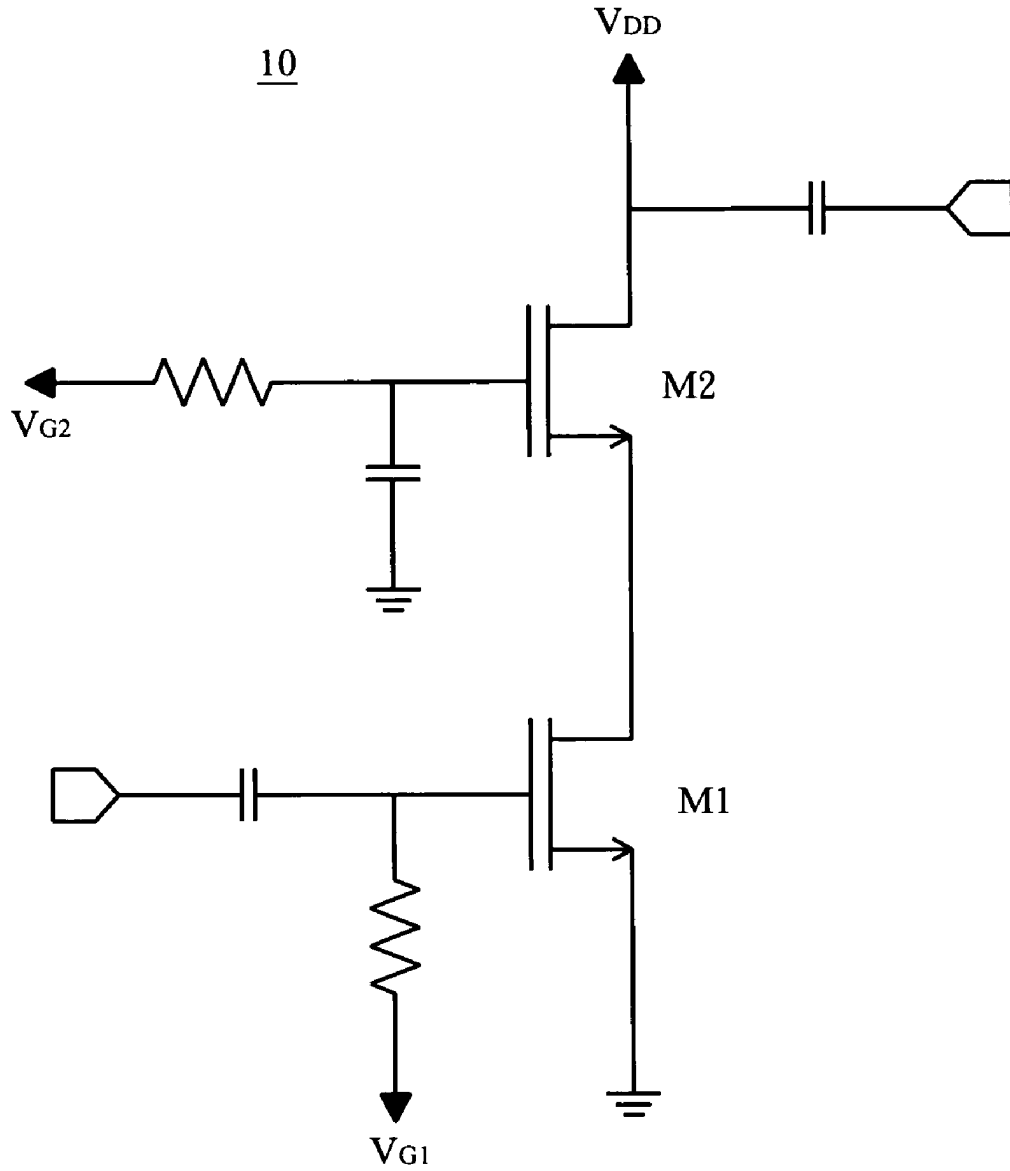


FIG.2  
(PRIOR ART)

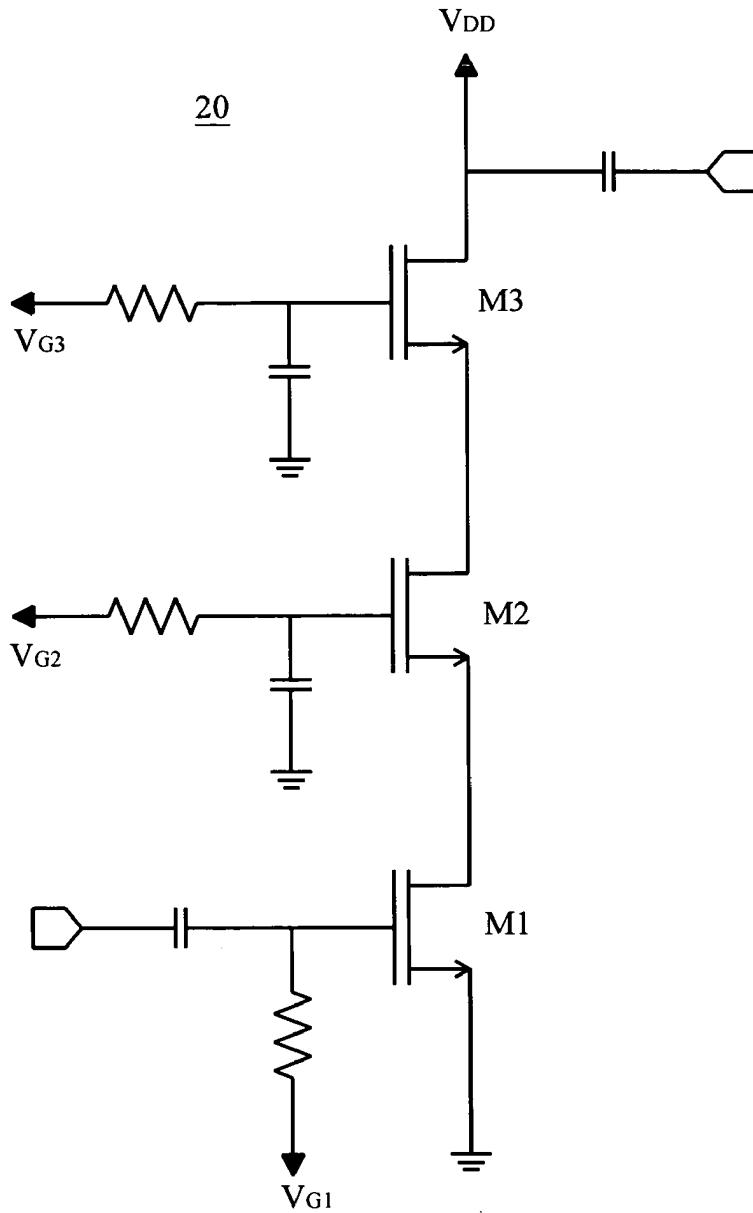


FIG.3  
(PRIOR ART)

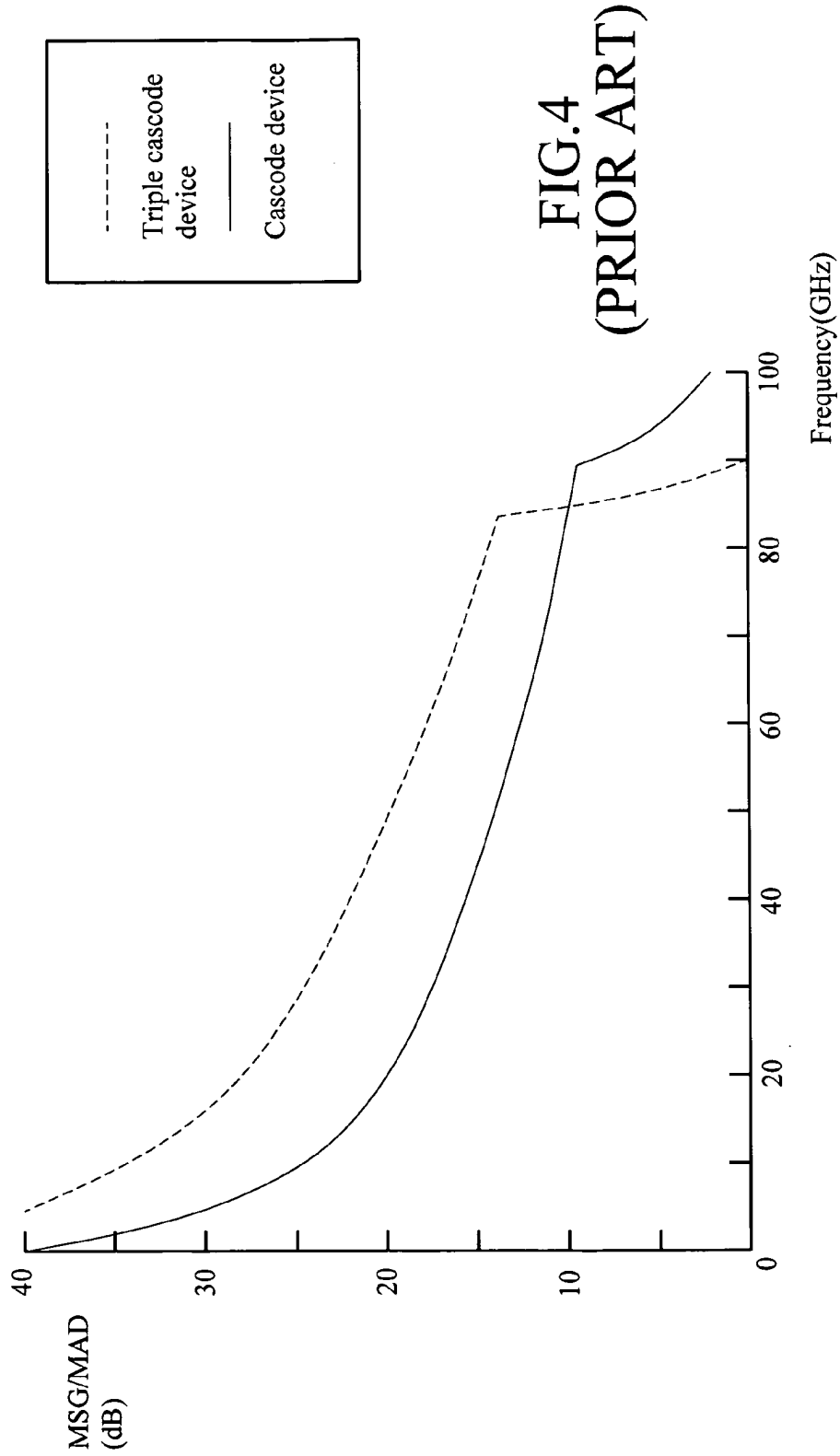


FIG.4  
(PRIOR ART)

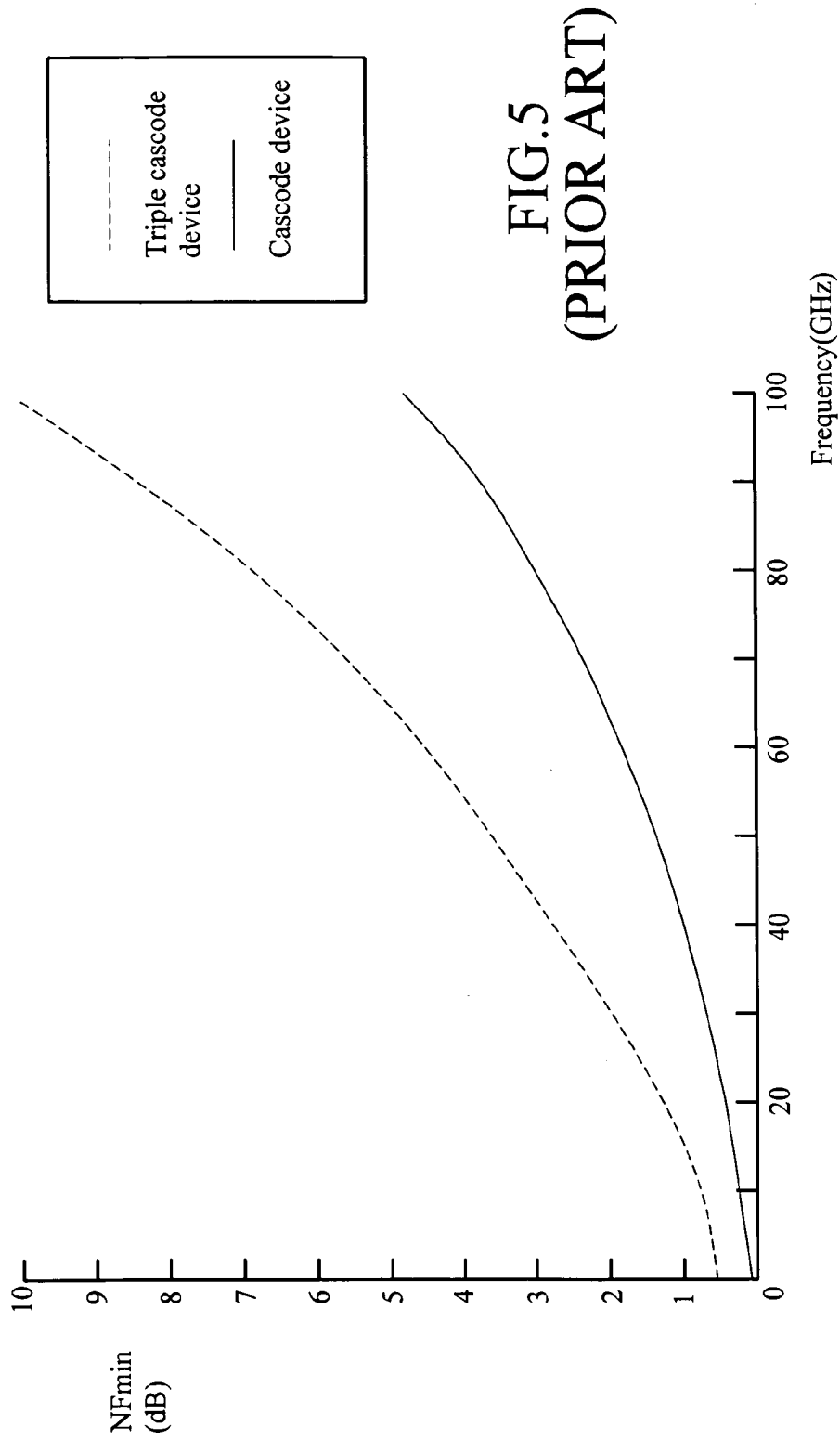


FIG. 5  
(PRIOR ART)

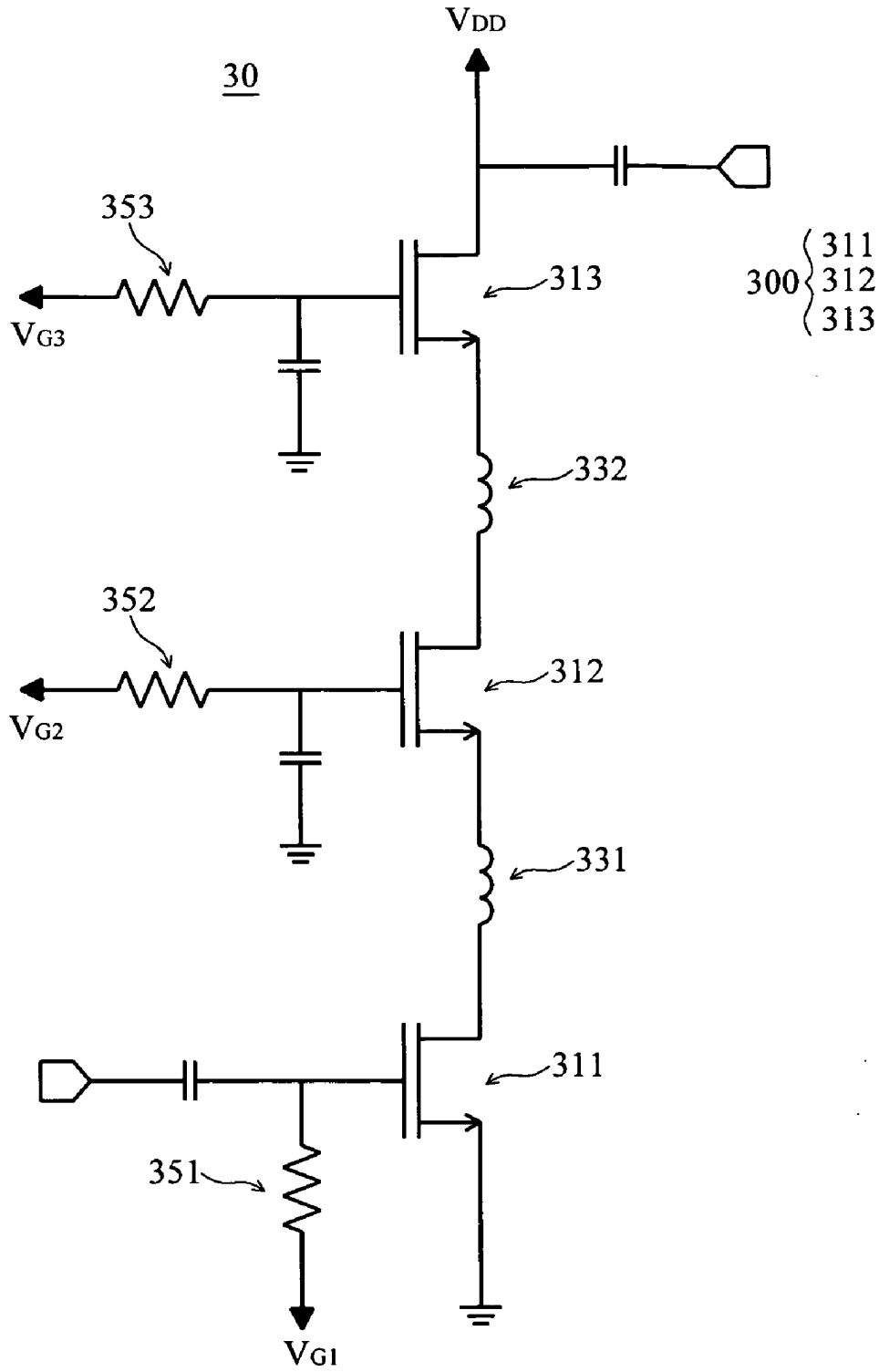


FIG.6

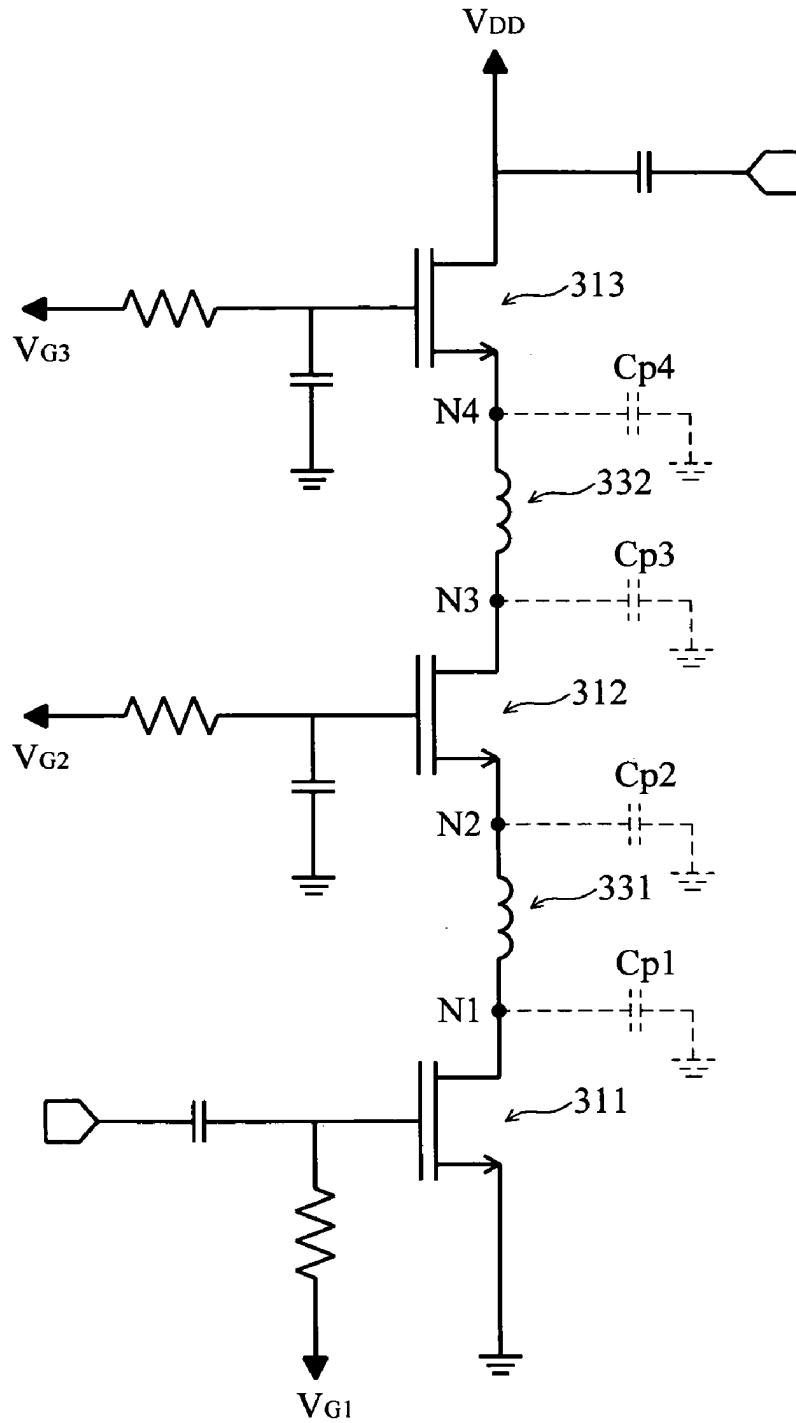


FIG. 7

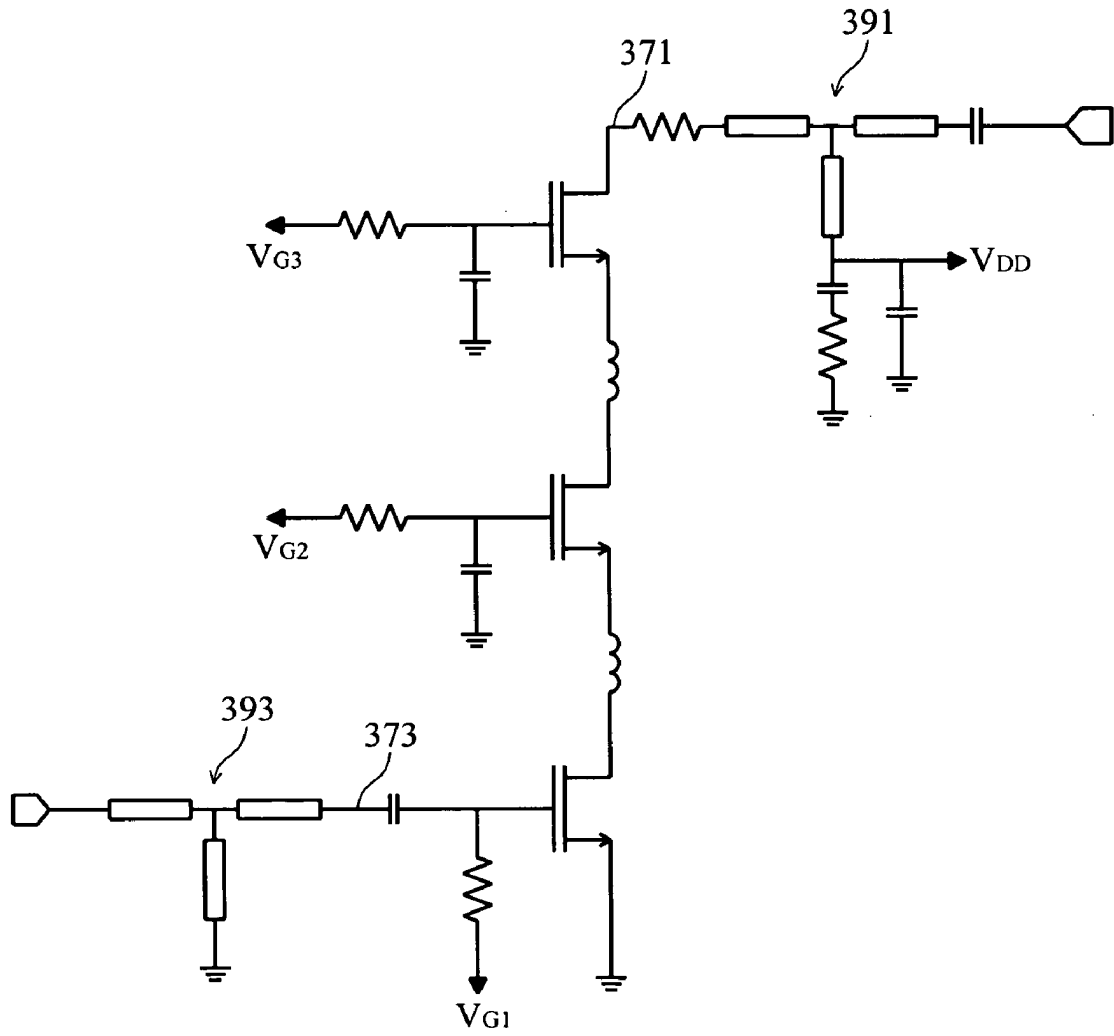


FIG.8

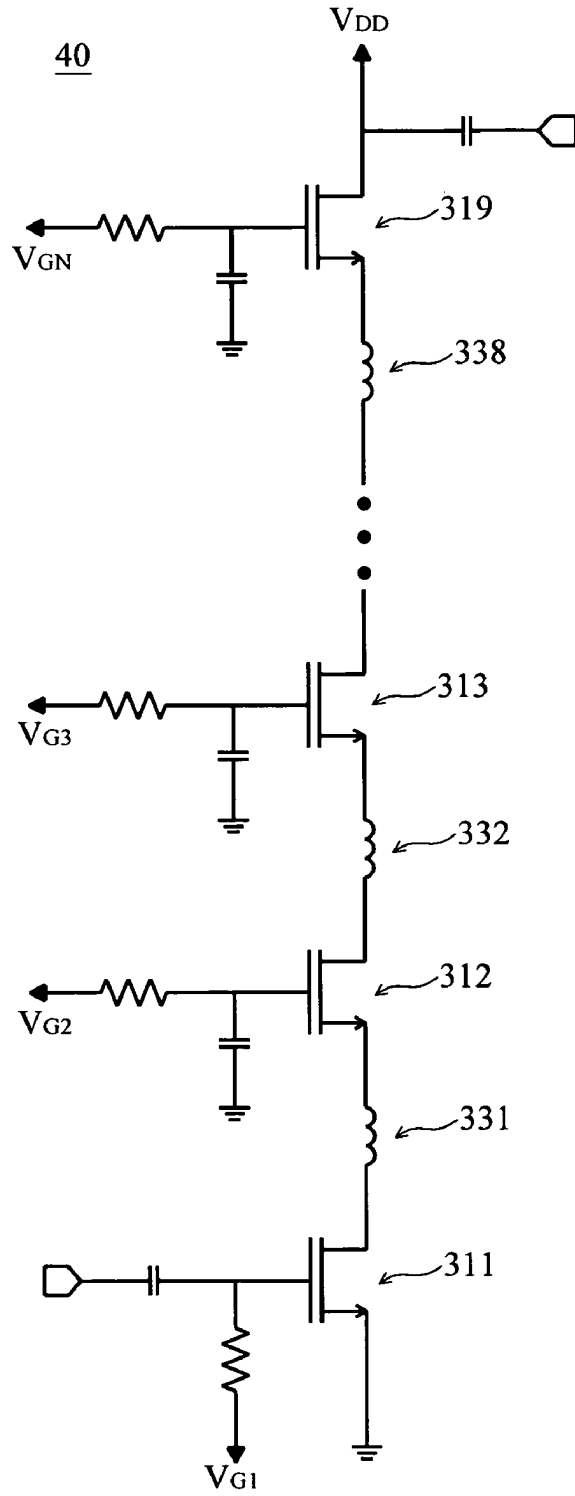


FIG.9

1

**LOW NOISE CASCODE AMPLIFIER**

## BACKGROUND OF THE INVENTION

## 1. Technical Field

The present invention generally relates to cascode amplifier, and more particularly to low noise cascode amplifier.

## 2. Description of the Prior Art

The integrated circuit always comprises an amplifier circuit for amplifying an input signal. In general, the metal-oxide semiconductor device (MOS) or the cascode can be the amplifier circuit. Referring to FIG. 1, what is shown is a circuit diagram for the MOS as an amplifier according to the prior art. The amplifier comprises a MOS M1 and a current source I, wherein the source of the MOS M1 is grounded, the gate of the MOS M1 connects to a bias voltage VI, and the drain of the MOS M1 connects to the current source I to form a common source MOS. Although the MOS M1 can be used to amplify the input signal, the resulting gain is always too low to be a fine amplifier, and leads to the limited application of the amplifier.

Referring to FIG. 2, what is shown is a circuit diagram for a cascode device according to the prior art. The cascode device 10 comprises a common source transistor M1 and a common gate transistor M2, and the gain of the cascode device 10 is higher than the common source MOS as shown in FIG. 1.

In addition, the triple cascode device 20 comprises three transistors in series to improve the gain. As shown in FIG. 3, the triple cascode device 20 comprises a common source transistor M1, a common gate transistor M2, and a common gate transistor M3.

Referring to FIG. 4, what is shown is a gain-frequency diagram for a cascode device and a triple cascode device according to the prior art. In this embodiment, the transistor M1 is a 16-finger NMOS with a total gate width of 40  $\mu\text{m}$ , the transistor M2 is a 24-finger NOMS with a total gate width of 60  $\mu\text{m}$ , and the transistor M3 is a 32-finger NMOS with a total gate width of 80  $\mu\text{m}$ . Furthermore, the dashed line is the curve of the gain (MSG/MAG)-frequency of the triple cascode device 20, and the continuous line is the curve of the gain (MSG/MAG)-frequency of the cascode device 10, as shown in FIG. 4, wherein the MSG is the maximum stable gain, and the MAG is the maximum available gain.

The MSG of the triple cascode device 20 is 21.5 dB, and the MSG of the cascode device 10 is 15.3 dB, while the operating frequency is 40 GHz. In another words, the gain of the triple cascode device 20 is higher than that of the cascode device 10 or the common source MOS. Moreover, the triple cascode device 20 has the following advantages: high input impedance, high output impedance, high gain, compact size, and so forth.

Although the triple cascode device 20 provides the above advantages, it also produces noise, which limits the application of the triple cascode device 20. Referring to FIG. 5, what is shown is a noise-frequency diagram for a cascode device and a triple cascode device according to the prior art. The dashed line is the curve of the noise ( $Nf_{min}$ , minimum noise figure)-frequency of the triple cascode device 20, and the continuous line is the curve of the noise ( $Nf_{min}$ )-frequency of the cascode device 10.

The  $Nf_{min}$  of the triple cascode device 20 is 3.5 dB, and the  $Nf_{min}$  of the cascode device 10 is 2.8 dB, while the operating frequency is 40 GHz. Therefore, the triple cascode device 20

2

cannot be a suitable low noise amplifier (LNA) for a wireless transceiver due to its high noise figure.

## SUMMARY OF THE INVENTION

It is a feature of the present invention to provide a low noise cascode amplifier, wherein the cascode device comprises at least one inductor for reducing the noise figure of the cascode device, so that the cascode device can be used as a low noise cascode amplifier.

It is another feature of the present invention to provide a low noise cascode amplifier, wherein the inductor(s) within the cascode device and the parasitic capacitance(s) can be incorporated together to become a resonator, thusly resulting in the noise reduction of the cascode device and the improved stability thereof.

It is still another feature of the present invention to provide a low noise cascode amplifier, wherein the inductance of the inductor(s) can be adjusted according to the value of the parasitic capacitance, resulting in the high frequency noise being reduced.

It is still another feature of the present invention to provide a low noise cascode amplifier, wherein the inductance of the inductor(s) can be adjusted according to the operating frequency of the cascode device to reduce the noise figure of the low noise cascode amplifier being operated at a designated frequency.

According to the above features, a low noise cascode amplifier includes the followings: a first transistor; a first inductor connected to the first transistor; a second transistor connected to the first inductor; a second inductor connected to the second transistor; and a third transistor connected to the second inductor.

According to the above features, another low noise cascode amplifier comprises the following: a cascode device comprising three or more than three transistors in series; and at least one inductor positioned between the adjacent transistors.

The present invention can be best understood through the following description and accompanying drawings.

## BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a circuit diagram of the MOS as an amplifier according to the prior art;

FIG. 2 is a circuit diagram for a cascode device according to the prior art;

FIG. 3 is a circuit diagram for a triple cascode device according to the prior art;

FIG. 4 is a gain-frequency diagram for a cascode device and a triple cascode device according to the prior art;

FIG. 5 is a noise-frequency diagram for a cascode device and a triple cascode device according to the prior art;

FIG. 6 is a circuit diagram for the low noise cascode amplifier according to an embodiment of the present invention;

FIG. 7 is a diagram for the parasitic capacitance of the low noise cascode amplifier according to the above embodiment of the present invention;

FIG. 8 is a circuit diagram for the low noise cascode amplifier according to an embodiment of the present invention; and

FIG. 9 is a circuit diagram for the low noise cascode amplifier according to another embodiment of the present invention.

## DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

Referring to FIG. 6, disclosed is a circuit diagram for a low noise cascode amplifier according to an embodiment of the

3

present invention. The low noise cascode amplifier **30** comprises a first transistor **311**, a second transistor **312**, a third transistor **313**, a first inductor **331**, and a second inductor **332**, wherein the noise figure can be reduced via the application of the inductors.

The series connection of the first transistor **311**, the second transistor **312**, and the third transistor **313** can form a cascode device, such as a triple cascode device **300**. The triple cascode device **300** is usually provided within various kinds of amplifiers, because of the advantages associated with high input impedance, high output impedance, high gain, and compact size.

However, the triple cascode device **300** cannot be considered a suitable low noise amplifier (LNA) for a wireless transceiver due its high noise figure. In the embodiment of the invention, the cascode device comprises at least one inductor to reduce the noise figure. For example, the cascode device comprises three or more transistors in series. Moreover, at least one inductor can be provided between the adjacent transistors in order to reduce the noise figure of the cascode device.

The first transistor **311** connects to the first inductor **331** and the second transistor **312** via the first inductor **331**. The second transistor **312** connects to the second inductor **332** and the third transistor **313** via the second inductor **332**. For example, the first transistor **311**, the second transistor **312**, and the third transistor **313** can be the NMOS, and the drain of the first transistor **311** can be connected to the source of the second transistor **312** via the first inductor **331**. The drain of the second transistor **312** can be connected to the source of the third transistor **313** via the second inductor **332**.

The first transistor **311** can be a common source metal-oxide semiconductor device, and the second transistor **312** and the third transistor **313** can be a common gate metal-oxide semiconductor device.

The parasitic capacitance will be generated as the first transistor **311**, the second transistor **312**, and the third transistor **313** operate at high frequency. For example, referring to FIG. 7, a first parasitic capacitance  $C_{p1}$  is generated at the node N1 between the first transistor **311** and the first inductor **331**, a second parasitic capacitance  $C_{p2}$  is generated at the node N2 between the first inductor **331** and the second transistor **312**, a third parasitic capacitance  $C_{p3}$  is generated at the node N3 between the second transistor **312** and the second inductor **332**, and a fourth parasitic capacitance  $C_{p4}$  is generated at the node N4 between the second inductor **332** and the third transistor **313**.

Please also refer to FIG. 3. For the triple cascode device (20) in the prior art, the parasitic capacitances of the common gate transistor M2 and M3 will cause excess noise. In the embodiment of the invention, the first inductor **331** and the second inductor **332** are provided within the low noise cascode device **30**, and the first inductor **331** and the second inductor **332** are incorporated within the first parasitic capacitance  $C_{p1}$ , the second parasitic capacitance  $C_{p2}$ , the third parasitic capacitance  $C_{p3}$ , and the fourth parasitic capacitance  $C_{p4}$  to thus become a resonator, so that the parasitic capacitances can be eliminated and the noise figure can be reduced.

The inductance L1 of the first inductor **331** and the inductance L2 of the second inductor **332** can be adjusted according to the value of the first parasitic capacitance  $C_{p1}$ , the second parasitic capacitance  $C_{p2}$ , the third parasitic capacitance  $C_{p3}$ , and the fourth parasitic capacitance  $C_{p4}$ . Furthermore, the inductance L1 of the first inductor **331** and the inductance L2 of the second inductor **331** can also be adjusted according to the operating frequency  $\omega$  of the triple cascode device **300**.

4

The impedance of the node N2 in the FIG. 7 is about

$$Z_{N2}=(S^2L_2C_{p3}+1)/S(C_{p3}+C_{p4}-\omega^2L_2C_{p3}C_{p4})$$

and the impedance of the node N4 is about

$$Z_{N4}=(S^2L_1C_{p1}+1)/S(C_{p1}+C_{p2}-\omega^2L_1C_{p1}C_{p2})$$

Where  $S=j\omega$ ,  $\omega$  represents the operation frequency

And  $L_1$  and  $L_2$  meet at about

$$L_1=(C_{p1}+C_{p2})/\omega^2C_{p1}C_{p2}$$

$$L_2=(C_{p3}+C_{p4})/\omega^2C_{p3}C_{p4}$$

Therefore, the noise figure of the triple cascode device **300** will be reduced because of the high impedance on the nodes N2 and N4. Moreover, the stability of the triple cascode device **300** can also be improved as a low noise amplifier.

In practical application, the gates of the first transistor **311**, the second transistor **312**, and the third transistor **313**, can respectively connect to a first resistance **351**, a second resistance **352**, and a third resistance **353** to bias the gate of each transistor. In addition, a T-matching network can be utilized to simplify and implement the input and output matching circuit. For example, a first T-matching network **391** can be provided on the input terminal **371** to serve as an input impedance device and a second T-matching network **393** can be provided on the output terminal **373** to serve as an output impedance device, as shown in FIG. 8.

Referring to FIG. 9, disclosed is a circuit diagram of the low noise cascode amplifier according to another embodiment of the present invention. The low noise cascode amplifier **40** comprises a first transistor **311**, a second transistor **312**, a third transistor **313**, at least one nth transistor **319**, a first inductor **331**, a second inductor **332**, and at least one (n-1)th inductor **338**, wherein n is an integer greater than 4. The noise figure of the low noise cascode amplifier **40** can be reduced via the application of said inductors.

The first transistor **311** connects to the first inductor **331**, and connects to the second transistor **312** via the first inductor **331**. The second transistor **312** connects to the second inductor **332**, and connects to the third transistor **313** via the second inductor **332**. The third transistor **313** connects to the (n-1)th inductor **338**, and connects to the nth transistor **319** via the (n-1)th inductor **338**. In one embodiment of the invention, the number of the nth transistor **319** and the (n-1)th inductor **338** can be one or more than one. For example, a third inductor, a fourth transistor, an (n-1)th inductor, and an nth transistor can connect to the third transistor **338**, in turn, to form an nth cascode device. The first transistor **331**, the second transistor **332**, the third transistor **333**, and the nth transistor **319** can be the NMOS, wherein the first transistor is the common source MOS, and the second transistor **312**, the third transistor **313**, and the nth transistor **319** are the common gate MOS.

The above embodiments are only used to illustrate the present invention, and are not intended to limit the scope thereof. Many modifications of the above embodiments can be made without departing from the spirit of the present invention.

What is claimed is:

1. A low noise cascode amplifier, comprising:
  - a first transistor;
  - a first inductor connected to said first transistor, a first parasitic capacitance being generated between said first transistor and said first inductor;
  - a second transistor connected to said first inductor, a second parasitic capacitance being generated between said first inductor and said second transistor;

5

a second inductor connected to said second transistor, a third parasitic capacitance being generated between said second transistor and said second inductor; and  
 a third transistor connected to said second inductor, a fourth parasitic capacitance being generated between said second inductor and said third transistor.

2. The low noise cascode amplifier of claim 1, wherein the inductance of said first inductor and said second inductor is adjusted according to the value of said first parasitic capacitance, said second parasitic capacitance, said third parasitic capacitance, and said fourth parasitic capacitance.

3. The low noise cascode amplifier of claim 2, wherein the inductance of said first inductor and said second inductor is adjusted according to the operating frequency of said amplifier.

4. The low noise cascode amplifier of claim 1, wherein the value of said first parasitic capacitance is  $C_{p1}$ , the value of said second parasitic capacitance is  $C_{p2}$ , the operating frequency of said amplifier is  $\omega$ , and the inductance L1 of said first inductor is approximately  $(C_{p1}+C_{p2})/\omega^2 C_{p1} C_{p2}$ .

5. The low noise cascode amplifier of claim 1, wherein the value of said third parasitic capacitance is  $C_{p3}$ , the value of said fourth parasitic capacitance is  $C_{p4}$ , the operating frequency of said amplifier is  $\omega$ , and the inductance L2 of said second inductor is approximately  $(C_{p3}+C_{p4})/\omega^2 C_{p3} C_{p4}$ .

6. A low noise cascode amplifier comprising:  
 a first transistor;  
 a first inductor connected to said first transistor;  
 a second transistor connected to said first inductor;  
 a second inductor connected to said second transistor;  
 a third transistor connected to said second inductor; and  
 at least one nth transistor and at least one (n-1)th inductor, wherein n is an integer equal to or greater than 4, said nth transistor being connected to said third transistor via said (n-1)th inductor.

7. The low noise cascode amplifier of claim 1, wherein the gate of said first transistor connects to a first resistance, the

6

gate of said second transistor connects to a second resistance, and the gate of said third transistor connects to a third resistance.

8. The low noise cascode amplifier of claim 1, further comprising an input terminal that connects to a first T-matching network and an output terminal that connects to a second T-matching network.

9. A low noise cascode amplifier, comprising:  
 a cascode device comprising three or more transistors in series, each of said transistors having a gate connected to a resistance; and  
 at least one inductor positioned between said adjacent transistors, a respective parasitic capacitance being generated between each of said transistors and a corresponding inductor.

10. A low noise cascode amplifier, comprising:  
 a cascode device comprising three or more transistors in series;  
 at least one inductor positioned between said adjacent transistors, a respective parasitic capacitance being generated between each of said transistors and a corresponding inductor; and  
 an input terminal that connects to a first T-matching network, and an output terminal that connects to a second T-matching network.

11. A low noise cascode amplifier, comprising:  
 a cascode device comprising three or more transistors in series, said cascode device comprises a first transistor, a second transistor, a third transistor, and an nth transistor, wherein n is an integer equal to or greater than 4; and  
 at least one inductor positioned between said adjacent transistors, a respective parasitic capacitance being generated between each of said transistors and a corresponding inductor.

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